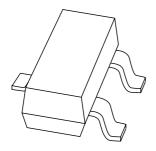
DISCRETE SEMICONDUCTORS

DATA SHEET



PMBS3906 PNP general purpose transistor

Product data sheet Supersedes data of 1999 Apr 22 2004 Feb 02



PNP general purpose transistor

PMBS3906

FEATURES

• Low current (max. 100 mA)

• Low voltage (max. 40 V).

APPLICATIONS

• General purpose switching and amplification, e.g. telephony and professional communication equipment.

DESCRIPTION

PNP transistor in a SOT23 plastic package. NPN complement: PMBS3904.

MARKING

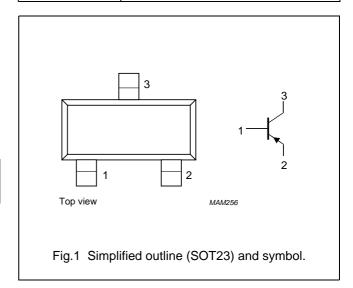
TYPE NUMBER	MARKING CODE(1)		
PMBS3906	*O6		

Note

* = p : Made in Hong Kong.
 * = t : Made in Malaysia.
 * = W : Made in China.

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



ORDERING INFORMATION

TYPE	PACKAGE		
NUMBER	NAME	DESCRIPTION	VERSION
PMBS3906	_	plastic surface mounted package; 3 leads	SOT23

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-40	V
V _{CEO}	collector-emitter voltage	open base	_	-40	V
V _{EBO}	emitter-base voltage	open collector	-	-5	V
I _C	collector current capability		_	-100	mA
I _{CM}	peak collector current		-	-200	mA
I _{BM}	peak base current		-	-200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	_	250	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		–65	+150	°C

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	500	K/W

Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

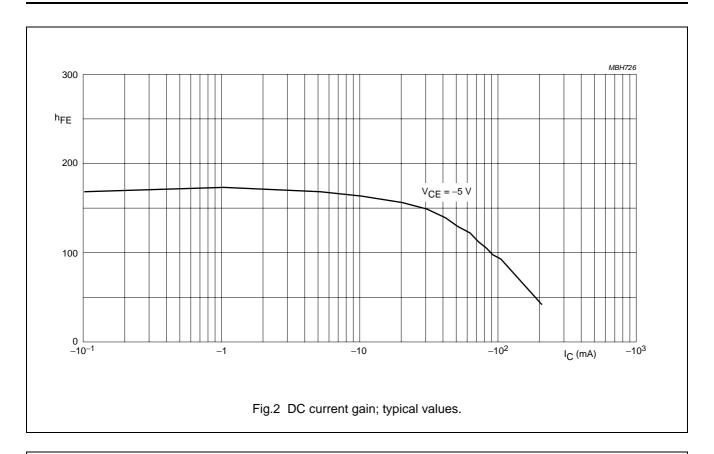
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$					
h_{FE} DC current gain $V_{CE} = -1 \text{ V; (see Fig.2)}$	50 nA	A			
$I_{c} = -0.1 \text{ mA}$ 60 -					
$I_C = -1 \text{ mA}$ 80 $-$					
$I_{\rm C} = -10 \text{mA}$ 100 30	00				
$I_{C} = -50 \text{ mA}$; note 1 60 -					
$I_{C} = -100 \text{ mA}; \text{ note 1}$ 30 –					
V_{CEsat} collector-emitter saturation voltage $I_{C} = -10$ mA; $I_{B} = -1$ mA $ -2$	250 m\	ıV			
$I_C = -50 \text{ mA}; I_B = -5 \text{ mA}; \text{ note 1}$ 4	400 m\	ıV			
V_{BEsat} base-emitter saturation voltage $I_{C} = -10 \text{ mA}$; $I_{B} = -1 \text{ mA}$ $ -8$	350 m\	ıV			
$I_C = -50 \text{ mA}$; $I_B = -5 \text{ mA}$; note 1 $ -9$	950 m\	٦V			
$I_E = i_e = 0$; $V_{CB} = -5$ V; $f = 100$ MHz $-$ 4.5	.5 pF	F			
$I_C = I_C = 0$; $VE_B = -0.5 \text{ V}$; $f = 100 \text{ MHz}$ – 12	2 pF	F			
$I_{C} = -10 \text{ mA}; V_{CE} = -20 \text{ V};$ $I_{C} = 100 \text{ MHz}$	MI	ИНz			
F noise figure $ I_C = -100 \ \mu\text{A}; \ V_{CE} = -5 \ V; \ R_S = 1 \ k\Omega; \qquad - \qquad 4 $ $ f = 10 \ Hz \ to \ 15.7 \ kHz $	dB	В			
Switching times (between 10% and 90% levels); (see Fig.3)					
t_{on} turn-on time $I_{Con} = -10 \text{ mA}; I_{Bon} = -1 \text{ mA}; -100 \text{ mB}$	00 ns	S			
t _d delay time I _{Boff} = 1 mA - 50	o ns	S			
t _r rise time – 50	o ns	s			
t _{off} turn-off time – 70	00 ns	S			
t _s storage time – 60	00 ns	S			
t _f fall time – 10	00 ns	s			

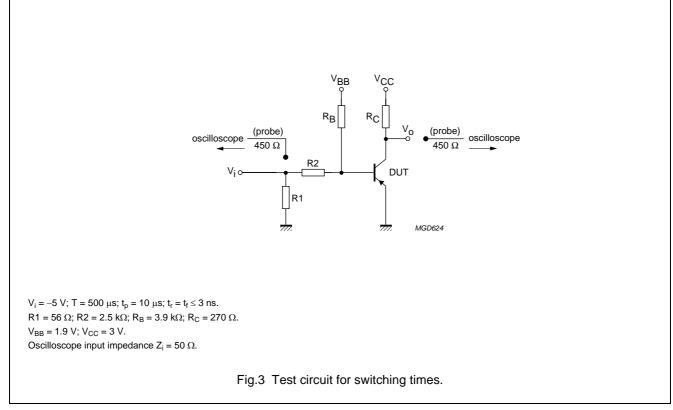
Note

1. Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$

PNP general purpose transistor

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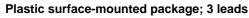




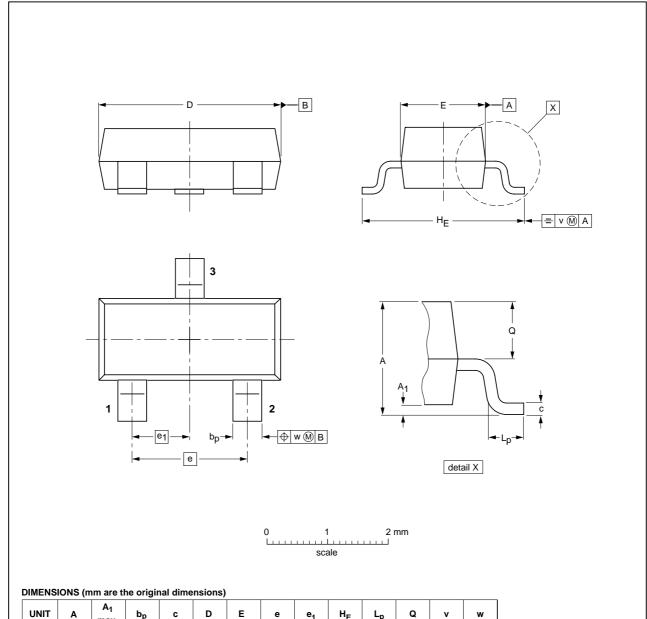
PNP general purpose transistor

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PACKAGE OUTLINE



SOT23



OUTLINE	LINE REFERENCES		EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT23		TO-236AB			-04-11-04 -06-03-16

 $\mathbf{H}_{\mathbf{E}}$

 $\mathbf{L}_{\mathbf{p}}$

0.45

0.55

0.1

2004 Feb 02 5

bp

0.48

0.38

max

0.9

PNP general purpose transistor

PMBS3906

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

- 1. Please consult the most recently issued document before initiating or completing a design.
- 2. The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

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